

## **Preliminary Technical Data**

## 2 W Filterless Class-D Stereo Audio Amplifier SSM2304

#### FEATURES

Filterless Class-D amplifier with built-in output stage
2 W into 4 Ω and 1.2 W into 8 Ω at 5.0 V supply with less than 10% THD
85% efficiency at 5.0 V, 2W into 4 Ω speaker
Better than 95dB SNR (signal-to-noise ratio)
Available in 16-lead 3 mm × 3 mm LFCSP
Single-supply operation from 2.2 V to 5.0 V
20 nA ultralow shutdown current
Short-circuit and thermal protection
Pop-and-click suppression
Built-in resistors reduce board component count
Default fixed 18dB gain and user-adjustable

#### **APPLICATIONS**

Notebooks and PCs Mobile phones MP3 players Portable gaming Portable electronics Educational toys

#### **GENERAL DESCRIPTION**

The SSM2304 is a fully integrated, high efficiency, Class-D stereo audio amplifier. It is designed to maximize performance for portable applications. The application circuit requires a minimum of external components and operates from a single 2.2 V to 5.0 V supply. It is capable of delivering 2 W of continuous output power with less than 10% THD + N driving a 4  $\Omega$  load from a 5.0 V supply.

The SSM2304 features a high efficiency, low noise modulation scheme. It operates with 85% efficiency at 2 W into 4  $\Omega$  from a 5.0 V supply and has a signal-to-noise ratio (SNR) that is better than 95 dB. PDM modulation is used to provide lower EMI-radiated emissions compared with other Class-D architectures.

The SSM2304 has a micropower shutdown mode with a typical shutdown current of 20 nA. Shutdown is enabled by applying a logic low to the  $\overline{\text{SD}}$  pin.

The architecture of the device allows it to achieve a very low level of pop and click. This minimizes voltage glitches at the output during turn-on and turn-off, thus reducing audible noise on activation and deactivation.

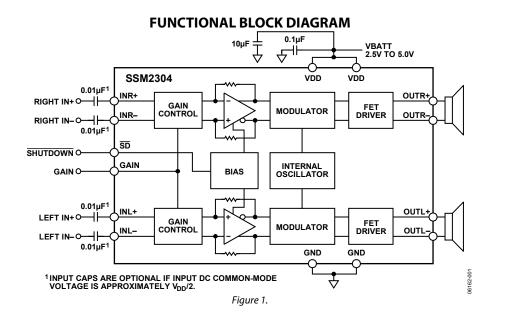
The fully differential input of the SSM2304 provides excellent rejection of common-mode noise on the input. Input coupling capacitors can be omitted if the dc input common-mode voltage is approximately  $V_{\rm DD}/2$ .

The SSM2304 also has excellent rejection of power supply noise, including noise caused by GSM transmission bursts and RF rectification. PSRR is typically 70 dB at 217 Hz.

The gain can be set to 6 dB or 18 dB utilizing the gain control select pin connected respectively to ground or  $V_{\rm DD}$ . Gain can also be adjusted externally by using an external resistor.

The SSM2304 is specified over the commercial temperature range  $(-40^{\circ}\text{C to }+85^{\circ}\text{C})$ . It has built-in thermal shutdown and output short-circuit protection. It is available in a 16-lead, 3 mm × 3 mm lead-frame chip scale package (LFCSP).

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#### **REVISION HISTORY**

7/06—Revision 0: Initial Version

## **SPECIFICATIONS**

 $V_{\text{DD}}$  = 5.0 V,  $T_{\text{A}}$  = 25°C,  $R_{\text{L}}$  = 8  $\Omega$ , Gain=6dB, unless otherwise noted

#### Table 1.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
DEVICE CHARACTERISTICS						
Output Power	Po	$R_L$ = 4 $\Omega, THD$ = 1%, f = 1 kHz, 20 kHz BW, $V_{DD}$ = 5.0 V				W
		$R_L = 8 \Omega$ , THD = 1%, f = 1 kHz, 20 kHz BW, $V_{DD} = 5.0 V$		1.4		W
		$R_L = 4 \Omega$ , THD = 1%, f = 1 kHz, 20 kHz BW, $V_{DD} = 3.6 V$		TBD		W
		$R_L = 8 \Omega$ , THD = 1%, f = 1 kHz, 20 kHz BW, $V_{DD} = 3.6 V$		0.615		W
		$R_L = 4 \Omega$ , THD = 1%, f = 1 kHz, 20 kHz BW, $V_{DD} = 2.5 V$		TBD		W
		$R_L = 8 \Omega$ , THD = 1%, f = 1 kHz, 20 kHz BW, V <sub>DD</sub> = 2.5 V		0.275		W
		$R_L = 4 \Omega$ , THD = 10%, f = 1 kHz, 20 kHz BW, $V_{DD} = 5.0 V$		3.3		W
		$R_L = 8 \Omega$ , THD = 10%, f = 1 kHz, 20 kHz BW, $V_{DD} = 5.0 V$		1.53		W
		$R_L = 4 \Omega$ , THD = 10%, f = 1 kHz, 20 kHz BW, $V_{DD} = 3.6 V$		TBD		W
		$R_L = 8 \Omega$ , THD = 10%, f = 1 kHz, 20 kHz BW, V <sub>DD</sub> = 3.6 V		0.77		W
		$R_L = 4 \Omega$ , THD = 10%, f = 1 kHz, 20 kHz BW, V <sub>DD</sub> = 2.5 V		TBD		W
		$R_L = 8 \Omega$ , THD = 10%, f = 1 kHz, 20 kHz BW, V <sub>DD</sub> = 2.5 V		0.35		W
Efficiency	η	$P_{OUT} = 2.5 \text{ W}, 4 \Omega, V_{DD} = 5.0 \text{ V}$		87		%
	'	$P_{OUT} = 1.4 \text{ W}, 8 \Omega, V_{DD} = 5.0 \text{ V}$		85		%
Total Harmonic Distortion + Noise	THD + N	$P_0 = 2$ W into 4 $\Omega$ each channel, f = 1 kHz, $V_{DD} = 5.0$ V		0.2		%
		$P_0 = 1$ W into 8 $\Omega$ each channel, $f = 1$ kHz, $V_{DD} = 3.6$ V		0.25		%
In suit Common Made Vielte se Danse	V	10 - 100 - 1000 = 3.00	1.0	0.25	V <sub>DD</sub> – 1	V
Input Common-Mode Voltage Range			1.0	<u> </u>	V <sub>DD</sub> — I	
Common-Mode Rejection Ratio		$V_{CM} = 2.5 V \pm 100 \text{ mV}$ at 217 Hz		60 70		dB
Channel Separation	XTALK	$P_0 = 100 \text{ mW}$ , f = 1 kHz		78		dB
Average Switching Frequency	fsw			1.8		MHz
Differential Output Offset Voltage	Voos	G = 6 dB		2.0		mV
POWER SUPPLY						
Supply Voltage Range	V <sub>DD</sub>	Guaranteed from PSRR test	2.5		5.0	V
Power Supply Rejection Ratio	PSRR	$V_{\text{DD}}$ = 2.5 V to 5.0 V , 50 Hz, input floating/ground	70	85		dB
	PSRR <sub>GSM</sub>	$V_{RIPPLE} = 100 \text{ mV rms at } 217 \text{ Hz}$ , inputs ac GND, $C_{IN} = 0.01 \mu$ F, input referred		70		dB
Supply Current	lsy	$V_{IN} = 0 V$ , no load, $V_{DD} = 5.0 V$		7.0		mA
		$V_{IN} = 0 V$ , no load, $V_{DD} = 3.6 V$		6.5		mA
		$V_{IN} = 0 V$ , no load, $V_{DD} = 2.5 V$		5.2		mA
Shutdown Current	I <sub>SD</sub>	$\overline{SD} = GND$		20		nA
GAIN CONTROL						
Closed-Loop Gain	Av0	GAIN1 = 0V		6		dB
	Av1	$GAIN2 = V_{DD}$		12		dB
Differential Input Impedance	Z <sub>IN</sub>	$\overline{SD}$ = VDD, Av0 and Av1 modes		37.5		ΚΩ
		$\overline{SD} = GND$		210		KΩ
SHUTDOWN CONTROL						
Input Voltage High	VIH	lsy ≥ 1 mA		1.2		v
Input Voltage Low	VIH	$I_{SY} \leq 100A$ $I_{SY} \leq 300 \text{ nA}$		0.5		v
Turn-On Time	v⊪ twu	$\overline{SD}$ rising edge from GND to V <sub>DD</sub>		30		ms
Turn-Off Time						
	t <sub>sD</sub>	$\overline{SD}$ falling edge from $V_{DD}$ to GND		5		μs
Output Impedance	Zout	$\overline{SD} = GND$		>100		KΩ
NOISE PERFORMANCE						
NOISE PERFORMANCE Output Voltage Noise	en	$V_{DD}$ = 3.6 V, f = 20 Hz to 20 kHz, inputs are ac grounded, A <sub>V</sub> = 6 dB, A weighting		35		μV

## **ABSOLUTE MAXIMUM RATINGS**

Absolute maximum ratings apply at 25°C, unless otherwise noted.

#### Table 2.

Parameter	Rating
Supply Voltage	6 V
Input Voltage	V <sub>DD</sub>
Common-Mode Input Voltage	V <sub>DD</sub>
ESD Susceptibility	4 kV
Storage Temperature Range	–65°C to +150°C
Operating Temperature Range	-40°C to +85°C
Junction Temperature Range	–65°C to +165°C
Lead Temperature Range (Soldering, 60 sec)	300°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### THERMAL RESISTANCE

 $\theta_{JA}$  is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages.

#### Table 3. Thermal Resistance

Package Type	θ <sub>JA</sub>	οıc	Unit
16-lead, 3 mm × 3 mm LFCSP	44	31.5	°C/W

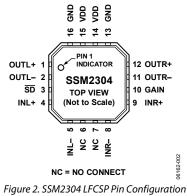
#### **ESD CAUTION**

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



## SSM2304

## **PIN CONFIGURATION AND FUNCTION DESCRIPTIONS**



#### Table 4. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	OUTL+	Inverting Output for Left Channel.
2	OUTL-	Noninverting Output for Left Channel.
3	SD	Shutdown Input. Active low digital input.
4	INL+	Noninverting Input for Left Channel.
5	INL-	Inverting Input for Left Channel.
6	NC	No Connect.
7	NC	No Connect.
8	INR-	Inverting Input for Right Channel.
9	INR+	Noninverting Input for Right Channel.
10	GAIN	Gain Selection. Digital input.
11	OUTR-	Noninverting Output for Right Channel.
12	OUTR+	Inverting Output for Right Channel.
13	GND	Ground for Output Amplifiers.
14	VDD	Power Supply for Output Amplifiers.
15	VDD	Power Supply for Output Amplifiers.
16	GND	Ground for Output Amplifiers.

## **TYPICAL PERFORMANCE CHARACTERISTICS**

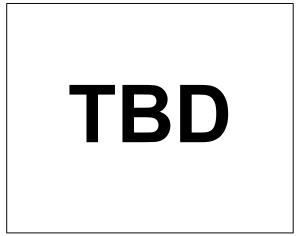


Figure 3. THD + N vs. Output Power into  $4 \Omega$ ,  $A_V = 12 dB$ 

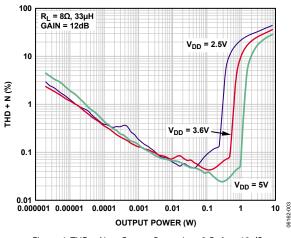


Figure 4. THD + N vs. Output Power into 8  $\Omega$ ,  $A_V = 12 \, dB$ 

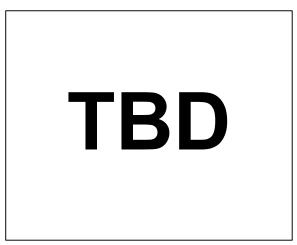
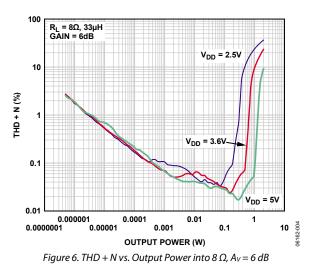


Figure 5. THD + N vs. Output Power into 4  $\Omega$ ,  $A_V = 6 dB$ 





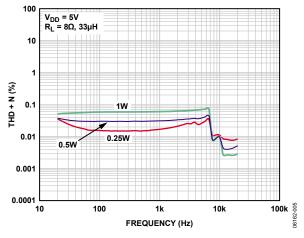


Figure 7. THD + N vs. Frequency,  $V_{DD} = 5.0 V$ 

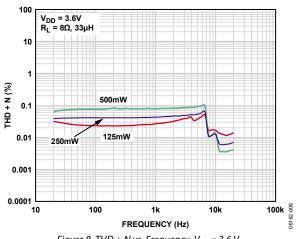
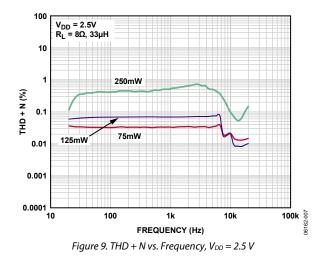


Figure 8. THD + N vs. Frequency,  $V_{DD} = 3.6 V$ 

## SSM2304



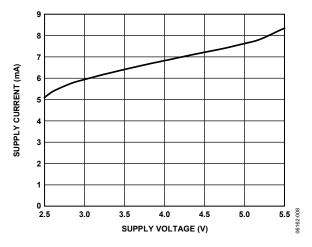
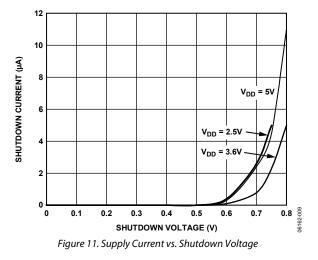


Figure 10. Supply Current vs. Supply Voltage, No Load



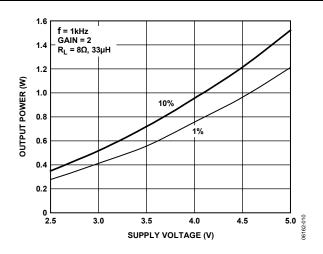


Figure 12. Maximum Output Power vs. Supply Voltage

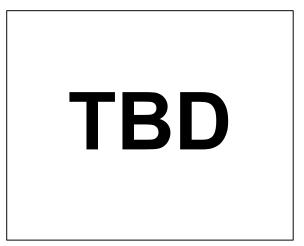


Figure 13. Efficiency vs. Output Power into 4  $\Omega$ 

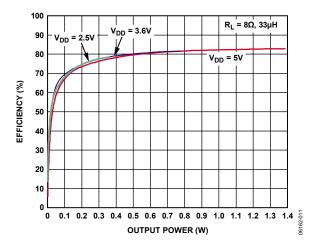


Figure 14. Efficiency vs. Output Power into 8  $\Omega$ 

## **Preliminary Technical Data**

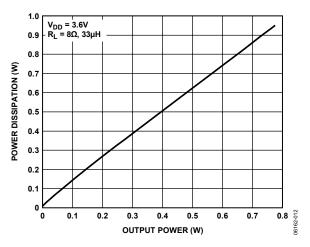


Figure 15. Power Dissipation vs. Output Power at  $V_{DD} = 3.6 V$ 

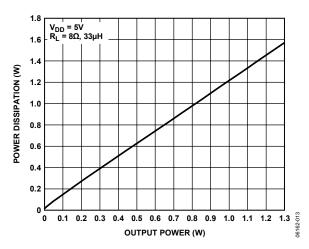


Figure 16. Power Dissipation vs. Output Power at  $V_{DD} = 5.0 V$ 

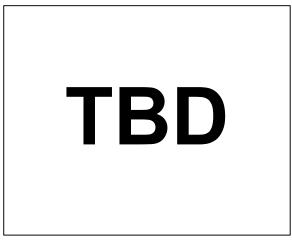


Figure 17. Output Power vs. Load Resistance, THD = 10%

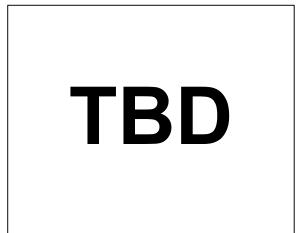


Figure 18. Output Power vs. Load Resistance, THD = 1%

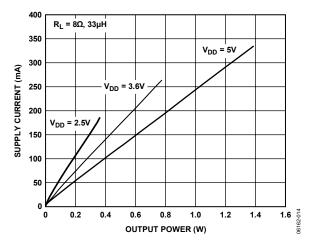
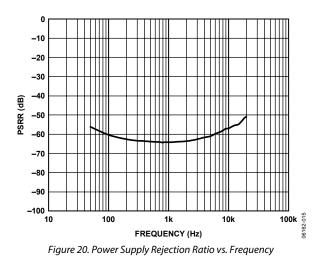
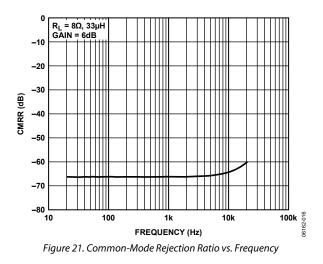


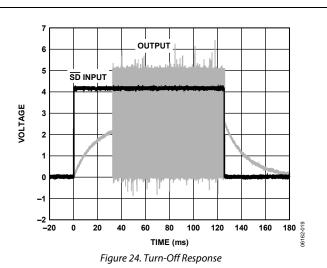
Figure 19. Output Power vs. Supply Current, One Channel



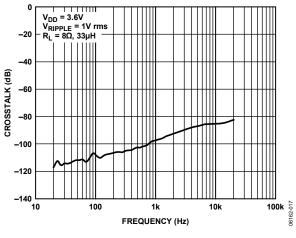
SSM2304

## SSM2304





**Preliminary Technical Data** 





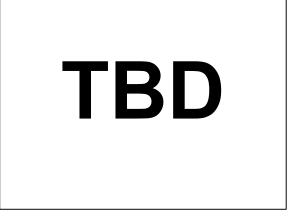
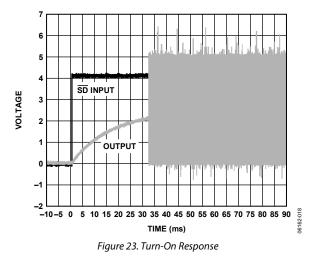


Figure 25. Output Frequency Spectrum



## **TYPICAL APPLICATION CIRCUITS**

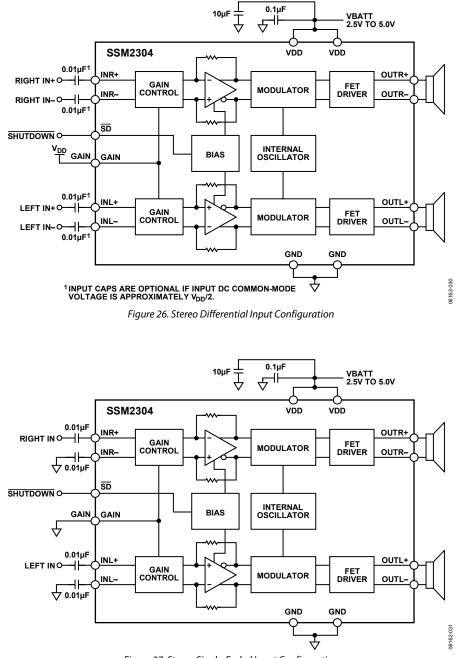


Figure 27. Stereo Single-Ended Input Configuration

## APPLICATION NOTES overview

The SSM2304 stereo Class-D audio amplifier features a filterless modulation scheme that greatly reduces the external components count, conserving board space and thus reducing systems cost. The SSM2304 does not require an output filter, but instead relies on the inherent inductance of the speaker coil and the natural filtering of the speaker and human ear to fully recover the audio component of the square-wave output. While most Class-D amplifiers use some variation of pulse-width modulation (PWM), the SSM2304 uses a  $\Sigma$ - $\Delta$  modulation to determine the switching pattern of the output devices. This provides a number of important benefits.  $\Sigma$ - $\Delta$  modulators do not produces a sharp peak with many harmonics in the AM frequency band, as pulse-width modulators often do.  $\Sigma$ - $\Delta$  modulation provides the benefits of reducing the amplitude of spectral components at high frequencies; that is, reducing EMI emission that might otherwise be radiated by speakers and long cable traces. The SSM2304 also offers protection circuits for overcurrent and temperature protection.

### GAIN SELECTION

The SSM2304 has a pair of internal resistors which set a 18dB of default gain of the amplifier.

It is possible to adjust the SSM2304 gain by using external resistors at the input. To set a gain lower than 18 dB refer to **Error! Reference source not found.** for differential input configuration and **Error! Reference source not found.** for single-ended configuration. The external gain configuration is calculated as

External Gain Settings = 300k/(37.5k+Rext)

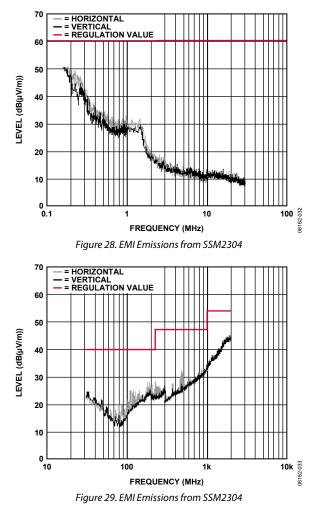
The gain pin is not connected internally, therefore its external connection is not required.

#### **POP-AND-CLICK SUPPRESSION**

Voltage transients at the output of audio amplifiers can occur when shutdown is activated or deactivated. Voltage transients as low as 10 mV can be heard as an audio pop in the speaker. Clicks and pops can also be classified as undesirable audible transients generated by the amplifier system, therefore as not coming from the system input signal. Such transients can be generated when the amplifier system changes its operating mode. For example, the following can be sources of audible transients: system power-up/ power-down, mute/unmute, input source change, and sample rate change. The SSM2304 has a pop-and-click suppression architecture that reduces this output transients, resulting in noiseless activation and deactivation.

#### **EMI NOISE**

The SSM2304 uses a proprietary modulation and spreadspectrum technology to minimize EMI emissions from the device. Figure 28 shows SSM2304 EMI emission starting from 100 kHz to 30 MHz. Figure 29 shows SSM2304 EMI emission from 30 kHz to 2 GHz. These figures clearly describe the SSM2304 EMI behavior as being well below the FCC regulation values, starting from 100 kHz and passing beyond 1 GHz of frequency. Although the overall EMI noise floor is slightly higher, frequency spurs from the SSM2304 are greatly reduced.



The measurements for Figure 28 and Figure 29 were taken with a 1 kHz input signal, producing 0.5 W output power into an 8  $\Omega$  load from a 3.6 V supply. Cable length was approximately 5 cm. The EMI was detected using a magnetic probe touching the 2" output trace to the load.

#### LAYOUT

As output power continues to increase, care needs to be taken to lay out PCB traces and wires properly between the amplifier, load, and power supply. A good practice is to use short, wide PCB tracks to decrease voltage drops and minimize inductance. Make track widths at least 200 mil for every inch of track length for lowest DCR, and use 1 oz or 2 oz of copper PCB traces to further reduce IR drops and inductance. A poor layout increases voltage drops, consequently affecting efficiency. Use large traces for the power supply inputs and amplifier outputs to minimize losses due to parasitic trace resistance. Proper grounding guidelines helps to improve audio performance, minimize crosstalk between channels, and prevent switching noise from coupling into the audio signal. To maintain high output swing and high peak output power, the PCB traces that connect the output pins to the load and supply pins should be as wide as possible to maintain the minimum trace resistances. It is also recommended to use a large-area ground plane for minimum impedances. Good PCB layouts also isolate critical analog paths from sources of high interference. High frequency circuits (analog and digital) should be separated from low frequency ones. Properly designed multilayer printed circuit boards can reduce EMI emission and increase immunity to RF field by a factor of 10 or more compared with double-sided boards. A multilayer board allows a complete layer to be used for ground plane, whereas the ground plane side of a doubleside board is often disrupted with signal crossover. If the system has separate analog and digital ground and power planes, the analog ground plane should be underneath the analog power plane, and, similarly, the digital ground plane should be underneath the digital power plane. There should be no overlap between analog and digital ground planes nor analog and digital power planes.

#### INPUT CAPACITOR SELECTION

The SSM2304 will not require input coupling capacitors if the input signal is biased from 1.0 V to  $V_{DD} - 1.0$  V. Input capacitors are required if the input signal is not biased within this recommended input dc common-mode voltage range, if high-pass filtering is needed (Figure 26), or if using a single-ended source (Figure 27). If high-pass filtering is needed at the input, the input capacitor along with the input resistor of the SSM2304 will form a high-pass filter whose corner frequency is determined by the following equation:

 $f_C = 1/(2\pi \times R_{IN} \times C_{IN})$ 

Input capacitor can have very important effects on the circuit performance. Not using input capacitors degrades the output offset of the amplifier as well as the PSRR performance.

#### PROPER POWER SUPPLY DECOUPLING

To ensure high efficiency, low total harmonic distortion (THD), and high PSRR, proper power supply decoupling is necessary. Noise transients on the power supply lines are short-duration voltage spikes. Although the actual switching frequency can range from 10 kHz to 100 kHz, these spikes can contain frequency components that extend into the hundreds of megahertz. The power supply input needs to be decoupled with a good quality low ESL and low ESR capacitor—usually around 4.7  $\mu$ F. This capacitor bypasses low frequency noises to the ground plane. For high frequency transients noises, use a 0.1  $\mu$ F capacitor as close as possible to the VDD pin of the device. Placing the decoupling capacitor as close as possible to the SSM2304 helps maintain efficiency performance.

# EVALUATION BOARD INFORMATION

The SSM2304 audio power amplifier is a complete low power, Class-D, stereo audio amplifier capable of delivering 2.8 W/channel into 4  $\Omega$  load. In addition to the minimal parts required for the application circuit, measurement filters are provided on the evaluation board so that conventional audio measurements can be made without additional components.

This section provides an overview of Analog Devices SSM2304 evaluation board. It includes a brief description of the board as well as a list of the board specifications.

#### Table 5. SSM2304 Evaluation Board Specifications

Parameter	Specification
Supply Voltage Range, VDD	2.5 V to 5.0 V
Power Supply Current Rating	1.5 A
Continuous Output Power, P <sub>0</sub> ( $R_L = 4 \Omega$ , f = 1 kHz, 22 kHz BW)	2 W
Minimum Load Impedance	4 Ω

#### **OPERATION**

Use the following steps when operating the SSM2304 evaluation board.

#### Power and Ground

1. Set the power supply voltage between 2.5 V and 5.0 V. When connecting the power supply to the SSM2304 evaluation board, make sure to attach the ground connection to the GND header pin first and then connect the positive supply to the VDD header pin.

#### Inputs and Outputs

- 1. Ensure that the audio source is set to the minimum level.
- 2. Connect the audio source to Inputs INL± and INR±.
- 3. Connect the speakers to Outputs OUTL± and OUTR±.

#### **External Gain Settings**

It is possible to adjust the SSM2304 gain lower than 18 dB using external resistors at the input, refer to **Error! Reference source not found.**6 and **Error! Reference source not found.**7 on the product data sheet for proper circuit configuration. For external gain configuration, use the following formula:

External Gain Settings = 300k/(37.5k+Rext)

#### Shutdown Control

The shutdown select header controls the shutdown function of the SSM2304. The shutdown pin on the SSM2304 is active low, meaning that a low voltage (GND) on this pin places the SSM2304 into shutdown mode.

- 1. Select jumper to 1-2 position. Shutdown pulled to  $V_{DD}$ .
- 2. Select jumper to 2-3 position. Shutdown pulled to GND.

#### Input Configurations

- 1. For differential input configuration with input capacitors do not place a jumper on JP8, JP9, JP10, and JP11.
- 2. For differential input configuration without input capacitors place a jumper on JP8, JP9, JP10, and JP11.

#### SSM2304 APPLICATION BOARD SCHEMATIC

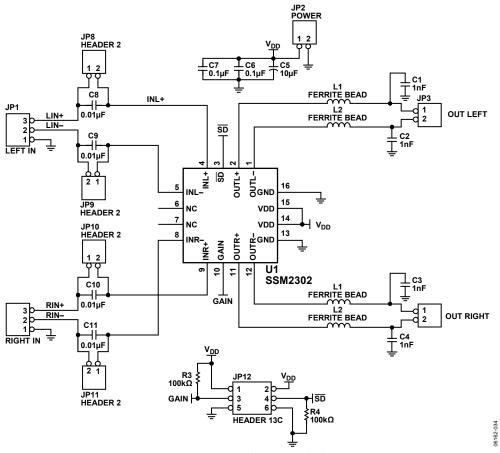


Figure 30. SSM2304 Application Board Schematic

#### Table 6. Reference Description Footprint Quantity Manufacturer/Part Number C8, C9, C10, C11 Capacitors, 0.01 µF 0402 4 Murata Manufacturing Co., Ltd./GRM15 C6, C7 Capacitor, 0.1 µF 0603 2 Murata Manufacturing Co., Ltd./GRM18 C5 Capacitor, 10 µF 0805 1 Murata Manufacturing Co., Ltd./GRM21 Murata Manufacturing Co., Ltd./GRM15 C1, C2, C3, C4 Capacitor, 1 nF 0402 4 2 Vishay/CRCW06031003F R3, R4 Resistor, 100 kΩ 0603 0402 4 Murata Manufacturing Co., Ltd./BLM15EG121 L1, L2, L3, L4 Ferrite bead U1 IC, SSM2304 $3.0 \text{ mm} \times 3.0 \text{ mm}$ 1 SSM2304CSPZ EVAL BOARD PCB evaluation board 1

#### SSM2304 STEREO CLASS-D AMPLIFIER EVALUATION MODULE COMPONENT LIST

#### SSM2304 APPLICATION BOARD LAYOUT

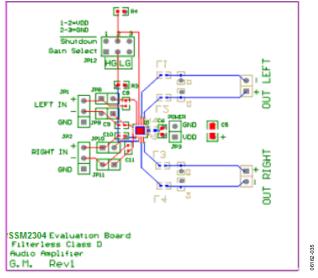
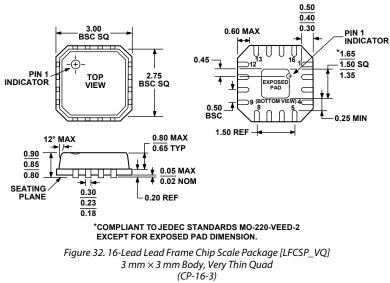


Figure 31. SSM2304 Application Board Layout

## **OUTLINE DIMENSIONS**



Dimensions shown in millimeters

#### **ORDERING GUIDE**

Model	Temperature Range	Package Description	Package Option	Branding
SSM2304CPZ-REEL <sup>1</sup>	-40°C to +85°C	16-Lead Lead Frame Chip Scale Package [LFCSP_VQ]	CP-16-3	A1F
SSM2304CPZ-REEL7 <sup>1</sup>	-40°C to +85°C	16-Lead Lead Frame Chip Scale Package [LFCSP_VQ]	CP-16-3	A1F

 $^{1}$  Z = Pb-free part.

## NOTES

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